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PBL 3798, PBL 3798/2 Subscriber Line Interface Circuit

Description

PBL 3798 is an analog Subscriber Line Interface Circuit (SLIC), which is fabricated in a 75 V bipolar, monolithic process.

The programmable, constant current feed circuit incorporates a switch mode regulator to minimize on-chip power dissipation. A stand-by state further reduces idle power dissipation, while allowing the supervisory functions to be active.

Tip-ring polarity is reversible without altering SLIC supervisory and voice frequency (vf) functions. Tip and ring outputs can be set to high impedance states. These and other operating states are activated via a parallel, four bit control word.

An external resistor controls the off-hook detector threshold current. A ground key detector with internal reference reports tip/ring dc current unbalance. The ring trip detector can operate with both balanced and unbalanced ringing systems. The three detectors are read via a shared output.

Ring and test relay drivers with internal clamp diodes are provided.

The complex or real two-wire impedance is set by a scaled, lumped element network.

Two- to four-wire and four- to two-wire signal conversion is provided by the SLIC in conjunction with either a conventional or a programmable CODEC/filter.

Longitudinal line voltages are suppressed by a control loop within the SLIC. The PBL 3798 package is 28-pin, dual-in-line; 32-pin or 44-pin j-leaded chip carrier.

The difference between PBL 3798 and PBL 3798/2 is mainly the longitudinal balance spec.



Figure 1. Block diagram.

Key Features

- On-chip switch mode regulator to minimize power dissipation
- Programmable, constant current feed
- Line feed characteristics independent of battery variations
- · Tip-ring polarity reversal function
- Tip and ring open circuit state; tip open with ring active state
- Detectors:
 - programmable loop current/ring ground detector
 - ground key detector
 - ring trip detector
- Ring and test relay drivers
- Line terminating impedance, complex or real, set by a simple external network
- Hybrid function with conventional or programmable CODEC/filters
- 70 dB longitudinal to metallic balance
- 79 mA peak longitudinal current suppression
- Idle noise < 7 dBrnC; <-83 dBup



Absolute Maximum Ratings

Temperature and Humidity 750 -55 +150 °C Storage temperature range T_{go1} -55 +150 °C Operating minimulation temperature range (Note 1) T_{go1} -40 +85 °C Power Supply V _{cc} -40 +6.5 V V _{cc} +6.5 +0.4 V V _{cc} with respect to ground V _{kc} -6.5 +0.4 V V V _{cc} with respect to ground V _{kc} -70 +0.4 V V _{cc} with respect to ground V _{kc} -70 +0.4 V V _{cc} with respect to ground V _{kc} -70 +0.4 V V _{cc} with respect to ground V _{kc} -70 +0.4 V V _{dc} with respect to ground V _{kc} -70 +0.4 V Storato T V _{dc} there (h) 	Parameter	Symbol	Min	Max	Unit
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V _{gas} V _{gas} -70 +0.4 V Prower Dissipation T V Prover Dissipation at T, velocity and the provement of		V _{EE}			
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Dutput current I_{OD} 3mATIPX and RINGX TerminalsTIPX or RINGX continuous voltage (Notes 5, 6) V_T, V_R -701VTIPX or RINGX, pulsed voltage, $t_w < 10$ ms and $t_{rep} > 10$ s (Notes 5, 6) V_T, V_R -705VTIPX or RINGX, pulsed voltage, $t_w < 1 \mu$ s and $t_{rep} > 10$ s (Notes 5, 6) V_T, V_R -9010VTIPX or RINGX, pulsed voltage, $t_w < 250$ ns and $t_{rep} > 10$ s (Notes 5, 6, 7) V_T, V_R -12015VTIPX or RINGX current I_{dc} -105105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°C°CCase temperature T_{Case} 090°C°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground (Notes 8, 9, 11) V_{eet} -58-40V		V _{OD}	-0.3	V _{cc}	
TIPX or RINGX continuous voltage (Notes 5, 6) $V_{T^1} V_R$ -701VTIPX or RINGX, pulsed voltage, $t_w < 10 \text{ ms and } t_{rep} > 10 \text{ s}$ (Notes 5, 6) $V_{T^1} V_R$ -705VTIPX or RINGX, pulsed voltage, $t_w < 1 \mu \text{ s and } t_{rep} > 10 \text{ s}$ (Notes 5, 6) V_T, V_R -9010VTIPX or RINGX, pulsed voltage, $t_w < 250 \text{ ns and } t_{rep} > 10 \text{ s}$ (Notes 5, 6, 7) V_T, V_R -12015VTIPX or RINGX currentI_{Ldc}-105105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground (Notes 8, 9, 11) V_{ee} -58-40V	Output current			3	mA
TIPX or RINGX, pulsed voltage, $t_w < 10 \text{ ms and } t_{rep} > 10 \text{ s}$ (Notes 5, 6) V_T, V_R -70 5VTIPX or RINGX, pulsed voltage, $t_w < 1 \mu \text{s}$ and $t_{rep} > 10 \text{ s}$ (Notes 5, 6) V_T, V_R -90 10VTIPX or RINGX, pulsed voltage, $t_w < 250 \text{ ns and } t_{rep} > 10 \text{ s}$ (Notes 5, 6, 7) V_T, V_R -120 15VTIPX or RINGX current I_{Ldc} -105 105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{ee} V_{cc} 4.75 5.25 V V_{ee} with respect to ground(Notes 8, 9, 11) V_{eet} -58 -40 V	TIPX and RINGX Terminals				
TIPX or RINGX, pulsed voltage, $t_w < 10 \text{ ms and } t_{rep} > 10 \text{ s}$ (Notes 5, 6) V_{T} , V_R -70 5VTIPX or RINGX, pulsed voltage, $t_w < 1 \mu \text{s}$ and $t_{rep} > 10 \text{ s}$ (Notes 5, 6) V_T , V_R -90 10VTIPX or RINGX, pulsed voltage, $t_w < 250 \text{ ns and } t_{rep} > 10 \text{ s}$ (Notes 5, 6, 7) V_T , V_R -120 15VTIPX or RINGX current I_{Ldc} -105 105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground (Notes 8, 9, 11) V_{eat} -58 -40 V		V _T , V _R	-70	1	
TIPX or RINGX, pulsed voltage, $t_w < 1 \ \mu s$ and $t_{rep} > 10 \ s$ (Notes 5, 6) V_T, V_R -9010VTIPX or RINGX, pulsed voltage, $t_w < 250 \ ns$ and $t_{rep} > 10 \ s$ (Notes 5, 6, 7) V_T, V_R -12015VTIPX or RINGX current I_{Ldc} -105105mA Recommended Operating Conditions SymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{ee} -5.25-4.75V V_{eat} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V	TIPX or RINGX, pulsed voltage, $t_w < 10$ ms and $t_{rev} > 10$ s (Notes 5, 6)	V _T , V _R	-70	5	V
TIPX or RINGX, pulsed voltage, $t_w < 250 \text{ ns and } t_{rep} > 10 \text{ s}$ (Notes 5, 6, 7) V_T , V_R -12015VTIPX or RINGX current I_{Ldc} -105105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V		V _T , V _R	-90	10	V
TIPX or RINGX currentI Ldc-105105mARecommended Operating ConditionsParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°CV _{cc} with respect to ground V_{cc} 4.755.25VV _{ee} with respect to ground V_{ee} -5.25-4.75VV _{eat} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V	TIPX or RINGX, pulsed voltage, $t_w < 250$ ns and $t_{rep} > 10$ s (Notes 5, 6, 7)	V _T , V _R	-120	15	V
ParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground V_{ee} -5.25-4.75V V_{eat} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V	TIPX or RINGX current	1	-105	105	mA
ParameterSymbolMinMaxUnitAmbient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{ee} with respect to ground V_{ee} -5.25-4.75V V_{eat} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V	Recommended Operating Conditions				
Ambient temperature T_{Amb} 070°CCase temperature T_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.755.25V V_{EE} with respect to ground V_{EE} -5.25-4.75V V_{pat} with respect to ground (Notes 8, 9, 11) V_{pat} -58-40V		Symbol	Min	Мах	Unit
Lase temperature I_{Case} 090°C V_{cc} with respect to ground V_{cc} 4.75 5.25 V V_{EE} with respect to ground V_{est} -5.25 -4.75 V V_{est} with respect to ground (Notes 8, 9, 11) V_{est} -58 -40 V					
V_{cc} with respect to ground V_{cc} 4.755.25V V_{ec} with respect to ground V_{ec} -5.25-4.75V V_{eat} with respect to ground (Notes 8, 9, 11) V_{eat} -58-40V		Amb T			
V_{EE}^{o} with respect to ground V_{EE}^{o} -5.25-4.75V V_{Rat}^{o} with respect to ground (Notes 8, 9, 11) V_{Rat}^{o} -58-40V		Case			
$V_{\text{Rat}}^{\text{LC}}$ with respect to ground (Notes 8, 9, 11) $V_{\text{Rat}}^{\text{LC}}$ -58 -40 V		V CC			
v_{Bat} with respect to ground (Notes 0, 3, 11) v_{Bat} "30 "40 V		V EE			
	GND2 with respect to GND1 (Note 10)	V _{Bat} V _{G12}	-56	-40	V

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Notes

- 1. The circuit includes thermal protection. Refer to section Over-temperature protection. Operation above 135 °C may degrade device reliability.
- 2. -
- 3. Values apply for junction temperature of 120°C without heatsink.
- 4. The GND1 and GND2 pins should be connected together via a direct printed circuit board trace.
- 5. V_{T} and V_{R} are referenced to ground. t_{w} is pulse width of a rectangular test pulse and t_{rec} is pulse repetition rate.
- 6. These voltage ratings require a diode to be installed in series with the VBAT pin as shown in figure 12 (D₇).
- 7. R_{F1} , $R_{F2} \ge 20 \Omega$ is also required. Pulse supplied to TIP and RING outside R_{F1} , R_{F2} .
- For long loop applications with -63 V < V_{Bat} < -56 V, the saturation guard reference voltage, V_{SGRef}, should be adjusted by calculating a value for resistor R_{SG} as described in the text. Note that the adjustment terminal, RSG, is available only on the 44-pin leaded chip carrier package.
- V_{Bat} should be applied with a ∂V_{Bat}/∂t < 4 V/µsec. A time constant of 2.6 µs is suggested (e.g. 5.6 Ω and 0.47 µF). The VBAT terminal must at all times be at a lower potential than any other terminal to maintain proper junction isolation. Refer to section Power-up sequence.
- 10. GND1 and GND2 must be connected before supply voltages.
- 11. A V_{Bat} of maximum -40 V may be used. However with a V_{Bat} of -40 to -46 V, the performance on long lines will degrade outside the specified limits. Parameters affected are; line current, longitudinal balance, Idel channel noise an V_{Bat} PSRR. Long lines is in this case outside the constant current range with the V_{Bat} dependent saturation guard activated.

Electrical Characteristics

0 °C ≤ T_{Amb} ≤ 70 °C, V_{CC} = +5 V ±5%, V_{EE} = -5V ±5%, -58 V ≤ V_{Bat} ≤ -46 V, GND1 = GND2, Z_{TR} (2-wire ac terminating impedance) = 600 Ω, Z_L (line impedance) = 600 Ω, R_{F1} = R_{F2} = 0 Ω, R_T = 60 kΩ, R_{RX} = 30 kΩ, R_{DC1} = R_{DC2} = 3.125 kΩ, R_{SG} = ∞, R_D = 51.1 kΩ, R_{CH} = 910 Ω, R_{Bat} = 10 Ω, C_{HP} = 0.33 µF, C_{DC} = 0.47 µF, C_D = 0.01 µF, C_{TC} = C_{RC} = 2200 pF, C_{CH1} = 0.047 µF, C_{CH2} = 1500pF, C_{FR} = 0.47 µF, C_D = 0.33 µF, L = 1mH, unless otherwise specified. The specifications are with respect to exact external component values. Terminal number reference "pin x/y" denotes 44-pin (x) and 28-pin (y) package terminal number respectively.

Parameter	Ref fig	Conditions	Min	Тур	Max	Unit
2-wire port						
Overload level, V _{TRO}	2	1% THD, E _L = 0, f = 1 kHz,	3.1	3.5		V _{Pk}
		(Note 1)	9.0	10.1		dBm
			9.0	10.1		dBu
Input impedance, Z _{TRX}		Note 3				
Longitudinal impedance, Z _{LoT} , Z _{LoR}	3	f ≤ 100 Hz		25	40	Ω/wire
Longitudinal current limit, ILOT, ILOR		f ≤ 100 Hz				
		Active state	20	28		mA _{rms} /wire
		Stand-by state	8.5	19		mA _{ms} /wire
Longitudinal to metallic balance, B		IEEE Standard 455-1985				
		0.2kHz < f < 3.4kHz, Note 4				
Standard version		Normal polarity	50	70		dB
		Reversed polarity	50	65		dB
-/2 version		Normal polarity	60	70		dB
		Reversed polarity	55	65		dB
		Average per lot, norm. polarity	65			dB



Figure 2. Overload level. $1/\omega C \ll R_L, R_L = 600 \text{ ohm},$ $R_T = 60 \text{ kohms}, R_{RX} = 30 \text{ kohms}.$

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ParameterDataSheet4U.com	Ref fig	Conditions	Min	Тур	Max	Unit
Metallic to longitudinal balance, B _{ML}		FCC part 68 paragraph 68.310				
		0.2kHz < f < 4.0kHz	40			dB
		f = 1.0 kHz		53		dB
Longitudinal to metallic balance, B	4	0.2kHz < f < 3.4kHz,				
		$B_{LME} = 20 \bullet \log \left \frac{E_{Lo}}{V_{TR}} \right $				
Standard version		Normal polarity	50	70		dB
		Reversed polarity	50	65		dB
-/2 version		Normal polarity	60	70		dB
		Reversed polarity	55	65		dB
Longitudinal to four wire balance, BLEE	4	0.2kHz < f < 3.4kHz				
C / LFE		$B_{LFE} = 20 \bullet \log \left \frac{E_{Lo}}{V_{TX}} \right $				
Standard version		Normal polarity	50	70		dB
		Reversed polarity	50	65		dB
-/2 version		Normal polarity	60	70		dB
		Reversed polarity	55	65		dB
Metallic to longitudinal balance, $B_{_{MLE}}$	5	$B_{MLE} = 20 \cdot \log \left \frac{E_{TR}}{V_{Lo}} \right , E_{RX} = 0$				
		0.2kHz < f < 4.0kHz	40			dB
		f = 1.0 kHz		53		dB
Four wire to longitudinal balance, $B_{_{\text{FLE}}}$	5	$B_{FLE} = 20 \cdot \log \left \frac{E_{RX}}{V_{Lo}} \right , E_{TR} \text{ source}$	e removed			
		0.2kHz < f < 4.0kHz	40			dB
		f = 1.0 kHz	10	53		dB
Lo C - - - - - - - - - - - - - - - - - -	IPX 2/27 PBL 3 INGX 3/28	3798	Figure Z _{LoT} = 2	3. Longitu Z _{LoR} = V_L	dinal input _{5T} + V _{LoR} I _{Lo}	impedance.
$= \underbrace{\begin{array}{c} E_{Lo} \\ - \end{array}} \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ $	PBL 3	$\begin{array}{c c} VTX\\32/21\\798\\RSN\\29/19\\R_{Rx} \\ \hline -\\ \hline$	and Lo balanc 1/ωC <	engitudinal- e. < 150 Ω, $R_{LR} = 300 Ω$		
C C VLo ETR RLT ETR B RLR C C C C RLT C C C C C C C C C C C C C C C C C C C	32 5 L 3798 X RS	$ \begin{array}{c} TX \\ Z/21 \\ B \\ SN \\ T/19 \\ R_{RX} \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	and fo balanc 1/ωC <	ur-wire-to-l e. < 150 Ω, R _{LR} = 300 Ω	e-to-longitud longitudinal 2, R ₇ = 60 l	(B _{FLE})

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Parameter	Ref fig	Conditions	Min	Тур	Max	Unit
2-wire return loss, r		$r = 20 \bullet \log \left \frac{Z_{L} + Z_{TR}}{Z_{L} - Z_{TR}} \right , \text{ Note 5}$				
		0.2 kHz $\leq f < 0.5$ kHz	30	32		dB
		0.5kHz ≤ f < 1.0kHz	25	27		dB
		1.0 kHz \leq f \leq 3.4 kHz	15	17		dB
Polarity reversal time, t _{nol}		Normal to reversed polarity or		4	15	ms
		reversed to normal polarity				
TIPX idle voltage, V _{Ti}		Normal polarity, stand-by				
- 11		$V_{Bat} = -48V$	-5.0	-3.5	-2.0	V
		$V_{Bat} = -63V$, Note 6	-5.0	-3.5	-2.0	V
TIPX to RINGX idle		Active and standby				
voltage, V _{Tro}		$V_{Bat} = -48V, R_{I} = open loop$				
Standard version		Normal polarity			42	V
		Reversed polarity	-42			V
-/2 version		Normal polarity			40	V
		Reversed polarity	-40			V
4-wire Transmit Port (VTX)						
Overload level, V _{TXO}	2	Load impedance > 20 k Ω ,	3.1	3.5		V _{Pk}
		f = 1 kHz, 1% THD, E _{Rx} = 0	9.0	10.1		dBu
		Note 7				
Output offset voltage, ΔV_{Tx}			-50	±5	+50	mV
Output impedance, z _{TX}		0.2 kHz \leq f \leq 3.4 kHz		10	20	Ω
4-wire Receive Port (RSN)						
RSN dc voltage, V _{RSN}		I _{RSN} = 0	-10	0	+10	mV
RSN impedance, z _{RSN}		0.2 kHz $\leq f \leq 3.4$ kHz	10	3	20	ohm
RSN current (I_{RSN}) to metallic		$0.2kHz \le f \le 3.4kHz$,		40	20	dB
loop current (I_{RSN}) to information loop current (I_{I}) gain, α_{RSN}		1		10		ab
		$\alpha_{RSN} = -\frac{\Gamma}{L}$				
		RSN				
Frequency Response						
Two-wire to four-wire, g ₂₋₄	6	0.3 kHz \leq f \leq 3.4 kHz	-0.1	±0.03	+0.1	dB
		Relative to 1.0 kHz, 0 dBu				
		E _{RX} = 0 V, (Notes 2, 8)				
Four-wire to two-wire, g ₄₋₂	6	0.3 kHz \leq f \leq 3.4 kHz	-0.1	±0.03	+0.1	dB
		Relative to 1.0 kHz, 0 dBu				
		E _L = 0 V, (Notes 2, 9)				
Four-wire to four-wire, g ₄₋₄	6	0.3 kHz \leq f \leq 3.4kHz	-0.1	±0.06	+0.1	dB
		Relative to 1.0 kHz, 0 dBu				
		E ₁ = 0 V, (Notes 2, 9)				
		<u> </u>				
Insertion Loss						
Insertion Loss Two-wire to four-wire, G ₂₋₄	6	0 dBu, 1 kHz, E _{RX} = 0	-0.15	±0.1	+0.15	dB



Figure 6. Frequency response, insertion loss, gain tracking, idle channel noise, THD, inter-modulation. $1/\omega C \ll R_{L}, R_{L} = 600 \Omega$, $R_{\tau} = 60 k\Omega$, $R_{RX} = 30 k\Omega$.

Parameter Data Sheet/LL com	Ref fig	Conditions	Min	Тур	Max	Unit
Four-wire to two-wire, $G_{4,2}$	6	0 dBu, 1 kHz, E, = 0	-0.15	±0.1	+0.15	dB
+-2		(Notes 9, 10)				
Four-wire to four-wire, G ₄₋₄	6	0 dBu, 1 kHz, E _L = 0 (Notes 9, 10)	-0.15	±0.1	+0.15	dB
Onlin Translation		(Notes 9, 10)				
Gain Tracking Two-wire to four-wire (Note 8) and	6	Referenced to -10 dBu, 1 kHz				
Four-wire to two-wire (Note 9)	U	+3 dBu to -30 dBu	-0.1		+0.1	dB
		-30 dBu to -55 dBu		±0.1		dB
Noise						
Idle channel noise at two-wire	6	$E_{RX} = E_{L} = 0$, Notes 2, 11				
(TIPX-RINGX) or four-wire (VTX) port		C-msg weighting		7	10	dBrnC
		Psophometrical weighting		-83	-80	dBup
Single Frequency out-of-band Noise (N				50	FF	dDu
Metallic, V _{TR} Longitudinal, V _{Lo}	7 7	12 kHz \leq f \leq 1 MHz 12 kHz \leq f \leq 90 kHz		-58 -68	-55 -63	dBu dBu
Longitudinal, V _{Lo}	7	90 kHz \leq f \leq 1 MHz		-53	-50	dBu
Total Harmonic Distortion				00		454
Two-wire to four-wire,	6	0.3 kHz \leq f \leq 3.4 kHz		-64	-50	dB
Four-wire to two-wire	-	0 dBu, 1 kHz test signal, Note 2		•		
Intermodulation						
Type 2f ₁ - f ₂	6	0.3 kHz < f ₁ , f ₂ < 3.4 kHz,				
		Level $f_1 = \text{level } f_2 = -25 \text{ to } 0 \text{ dBv}$				
Two wire to four wire		$f_1 \neq nf_2, f_2 \neq nf_1, \text{ Note 2}$		60	50	dD
Two-wire to four-wire		$E_{RX} = 0$		-60	-50	dB dB
Four-wire to two-wire Type f,±50 Hz	6	$E_{L} = 0$ 0.3kHz < f ₁ < 3.4kHz		-60	-50	dB
Type 1 ₁ ±30 Hz	0	Level 50 Hz = level $f_1 - 14 \text{ dB}$,				
		Level $f_1 = -15$ dBv to 0 dBv				
		f ₁ ≠ n • 50 Hz, Note 2				
Two-wire to four-wire		$E_{RX} = 0$		-65	-50	dB
Battery Feed Characteristics						
Loop current in constant current	17	$R_{DC1} = R_{DC2} = 3125 \ \Omega$	38	40	42	mA
region, II _{Ldc}		Active state $p = 1$,				
		Active polarity reversal state p = -1				
		250				
		$I_{Ldc} = p \bullet \frac{250}{R_{DC1} + R_{DC2}}$				
		Stand-by state p = 1	18	20	22	mA
		Stand-by polarity reversal state p = -1				
		125				
		$I_{Ldc} = p \bullet \frac{120}{R_{DC1} + R_{DC2}}$				
I am a second in a second a second	47					
Loop current in constant current region at maximum loop resistance, II, de	17	$R_{DC1} = R_{DC2} = 3125 \Omega$ Active state				
		$V_{Bat} = -48 \text{ V}, \text{ R}_{Lmax} = 750 \Omega$	38			mA
		$V_{Bat} = -63 \text{ V}, \text{ R}_{Lmax} = 1140 \Omega$	38			mA
		Bat , Lmax				
	- - -^	₩ 42/27				
V _{LD +} 67,5 ⁺ C	\perp	20				
	[]) i	Ldc PBL 3798	Figure	7. Single-	frequency of	out of band
<u> </u>	\downarrow		noise.			
		RINGX		tance value	es in Ω_{i}	
	Ň	43/28	$v_{Lo} = 1$ $1/\omega C$	1.6 • V' _{Lo} « 100 Ω		
			1100	100 22		

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ParameterDataSheet4U.com	Ref fig	Conditions	Min	Тур	Мах	Unit
Loop current outside constant current	17	$R_{DC1} = R_{DC2} = 3125 \ \Omega$				
region, I _{I de}		Active state				
200		V_{Bat} = -48 V, R_{Lmax} = 2 k Ω	15.5			mA
		$V_{Bat} = -63 \text{ V}, \text{ R}_{Lmax} = 2 \text{ k}\Omega$	23			mA
		Note 13				
Tip Open Circuit State						
TIPX current, I _{LTLkTo}	8	Tip open circuit state	-100	±5	100	μΑ
		$V_{Bat} < V_{TTO} < 0$				
RINGX current, I _{LRT0}	8	Tip open circuit state				
		$R_{LRGnd} = 0 \text{ ohm}$	23	35	50	mA
		$R_{LRGnd} = 2.5 \text{ k}\Omega, V_{Bat} = -63 \text{ V}$	22	24		mA
		$R_{LRGnd} = 2.5 \text{ k}\Omega, V_{Bat} = -48 \text{ V}$	16	18		mA
RINGX voltage, V _{RTo}	8	I _{LRTo} < 23 mA	V _{Bat} +1	V _{Bat} +4	V_{Bat} +14	V
Loop Current Detector						
Loop current detector conversion factor		$I_{LThOff} = K_{LThOff} / R_{D}$				
On-hook to off-hook, K _{LThOff}		Active, standby, polarity reversal state	395	465	535	V
		Tip open circuit state (Note 14)	745	930	1115	V
Loop current detector conversion factor		$I_{LTHOn} = K_{LTHOn}/R_{D}$				
Off-hook to on-hook, K _{LThOn}		Active, standby, polarity reversal state	348	410	472	V
		Tip open circuit state (Note 14)	655	820	985	V
Loop current detector conversion factor		Active, standby and				
hysteresis, K _{LTh}		Polarity reversal state (Note 15)	20	55	90	V
Dial pulse distortion		10 pps, Off-hook: 600 Ω		1	5	%
		On-hook: $\infty \Omega$				
Ring Trip Comparator Inputs (DT, DR)						
Offset voltage, ΔV_{DTR}	9	V_{Bat} + 1 V < V_{DT} , V_{DR} < -2 V				
		$R = 0 \Omega$	-20	±10	20	mV
		R = 200 kΩ	-40	±10	40	mV
Input offset current, ΔI _B	9	$V_{Bat} + 1 V < V_{DT}, V_{DR} < -2 V, R = 200 kG$		0.05	1	μΑ
Input bias current, I _в	9	$V_{Bat} + 1 V < V_{DT}, V_{DR} < -2 V, R = 200 kG$	2	0.1	1	μΑ
		$\frac{I_{B} = (I_{DT} + I_{DR})/2}{V_{Bat} + 1 \text{ V} < V_{DT}, V_{DR} < -2 \text{ V}}$				
Input resistance		$V_{Bat} + 1 V < V_{DT}, V_{DR} < -2 V$				
unbalanced, R _{DT} , R _{DR}				1		MΩ
balanced, R _{DTR}				3		MΩ
Common mode range, V _{DT} , V _{DR}			V _{Bat} +1		-2	V



Figure 8. Tip open circuit state. Figure 9. Ring trip comparator. $2V < V < |V_{Bat} + 1|$,

$$\frac{I_{DT} + I_{DR}}{2} = I_{B},$$

$$V_{DTR} = \Delta V_{DTR},$$

$$\Delta I_{B} = \frac{V'_{DTR} - V_{DTR}}{R}$$

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ParameterDataSheet4U.com	Ref fig	Conditions	Min	Тур	Max	Unit
Ground Key Detector						
Ground key detection threshold, R _{Gnd}	10	Active & stand-by states, $E_0 = E_1 = 1$				
		Note 19, 20				
		Switch S1 open	1.7		10.0	kΩ
		Switch S1 open, R _{sg} ≠∞	1.7		15.0	kΩ
		Switch S1 closed	0.9		10.0	kΩ
Longitudinal current threshold, I_{LoGkTh}	10	S1 closed		8		mA
Relay Driver Outputs (RINGRLY, TEST	RLY)					
On state voltage, V _{TRIV} , V _{RRIV}		$I_{\text{TRIy}}, I_{\text{RRLy}} = 25 \text{ mA}$				
		0°C < T _{Amb} < 25°C	V _{cc} -2.0	V _{cc} -1.8		V
		$25^{\circ}C < T_{Amb} < 70^{\circ}C$	V _{cc} -1.8	V _{cc} -1.6 5	V _{cc} -1.0	V
Off state leakage current, I _{TRIY} , I _{RRLy}		$V_{\text{TRly}}, V_{\text{RRly}} = V_{\text{Bat}}$		5	100	μA
Clamp voltage		$I_{\text{TRIV}}, I_{\text{RRLV}} = 25 \text{ mA}$	V _{Bat} -3		V _{Bat} -1	V
Digital Inputs (C1-C4, E0, E1, CHCLK)						
Input low voltage, V _{IL}					0.8	V
Input high voltage, V _{IH}			2.0			V
Input low current, I		$V_{IL} = 0.4 V$	-0.4			mA
Input high current, I _H		$V_{IH} = 2.4 V$			40	μA
Digital Output (DET)						
Output low voltage, V _{oL}		I _{OL} = 1.0 mA I _{OH} = -0.1 mA			0.45	V
Output high voltage, V _{OH}		I _{OH} = -0.1 mA	2.4			V
Resistive pull-up			12	15	18	kΩ
Switch Mode Regulator Transistor Out	put (L)					
Switch transistor saturation voltage, V_{ISat}		I ₁ = 100 mA, Note 16			1.5	V
Leakage current, I _{ILk}		$V_{I} = 0 V$			200	μA
Switch Mode Regulator Clock Input (Cl	HCLK)					
Clock frequency, f _{ChClk}			253	256	259	kHz
Rise and fall time					50	ns
Duty cycle ratio			46		54	%
Power Supply Rejection Ratio (PSRR)						
V _{cc} to two-wire port and		saturation guard off				
V _{cc} to four-wire port		50 Hz < f < 4 kHz	35			dB
rejection ratio, PSRR _{cc}		4 kHz < f < 50 kHz	30			dB
		saturation guard on				
		50 Hz < f < 50 kHz	20			dB
		Note 17				
V _{EE} to two-wire port and		50 Hz < f < 4 kHz	10			dB
V _{EE} to four-wire port		4 kHz < f < 50 kHz	0			dB
rejection ratio, PSRR _{EE}		Note 17				
V _{Bat} to two-wire port and		50 Hz < f < 4 kHz	25			dB
V _{Bat} to four-wire port		4 kHz < f < 50 kHz	20			dB
rejection ratio, PSRR _{Bat}		Note 17				



Figure 10. Ground key detector.

°C

ParameterDataSheet4U.com	Ref fig	Conditions	Min	Тур	Max	Unit
Power Supply Currents (relay drivers o	off)					
V _{cc} supply current, I _{cc}		On- or off-hook, active state		8	12	mA
V _{EE} supply current, I _{EE}		On- or off-hook, active state		6	9	mA
V _{Bat} supply current, I _{Bat}		On-hook, active state		3.5	6	mA
Power Dissipation						
On-hook total dissipation, P _{OnOp}		V _{Bat} = -48 V, Open circuit state		60	100	mW
On-hook total dissipation, Poss		V _{Bat} = -48 V, Stand-by state		190	350	mW
On-hook total dissipation, PORAct		$V_{Bat} = -48$ V, Active state		225	350	mW
Off-hook total dissipation, P		V_{Bat}^{a} = -48 V, Active state		700	1000	mW
		$R_{L}^{T} = 600 \Omega, R_{DC1} = R_{DC2} = 3.125 k\Omega$				
		Note 18				
Temperature Guard						
Junction temperature at threshold, T _{JG}				140		°C

Notes

- 1. The overload level is specified at the two-wire port with the signal source at the four-wire receive port, i.e. $E_L = 0$ in figure 2.
- 2. dBm is the ratio between power level P and a 1 mW reference power level, expressed in decibels, i.e.

 $dBm = 10 \bullet \log_{10} \frac{P}{1 \text{ mW}}$

Temperature guard hysteresis, $\partial T_{\mu c}$

dBu is the ratio between voltage Vrms and a 0.775 Vrms reference, expressed in decibels, i.e.

 $dBu = 20 \bullet \log_{10} \frac{Vrms}{0.775 Vrms}$

dBu = dBm at impedance level 600 Ω

dBv is the ratio between voltage V and a 1 V reference, expressed in decibels, i.e.

 $dBv = 20 \bullet \log_{10} \frac{V}{1 V}$

dBup is the ratio between voltage V_p , measured via a psophometrical filter and a 0.775 Vrms reference, expressed in decibels, i.e.

$$dBup = 20 \bullet \log_{10} \frac{V_p}{0.775 \text{ Vrms}}$$

dBrnC is the ratio between power level P_{c} , measured via a C-message filter and a 1 pW reference power level, expressed in decibels, i.e.

$$dBrnC = 10 \bullet \log_{10} \frac{P_c}{1 \text{ pW}}$$

 The two-wire impedance, Z_{TRX} is programmable by selection of external component values according to:

$$Z_{\text{TRX}} = Z_{\text{T}} / (G_{2-4} \bullet \alpha)$$

where:

 Z_{TRX} = impedance between the TIPX and RINGX terminals

 Z_{T} = programming network between the VTX and RSN terminals

$$\begin{split} & \mathsf{G}_{\text{2-4}} = \mathsf{TIPX}\text{-}\mathsf{RINGX} \text{ to } \mathsf{V}_{\text{TA}} \text{ gain, nom.} = 1 \text{ (0 dB } \pm 0.15 \text{ dB)} \\ & \alpha = \text{receive current gain, nominally} = 100 \text{ (40 dB } \pm 0.15 \text{ dB)} \\ & \text{The fuse resistors } \mathsf{R}_{\text{F}} \text{ add to the impedance presented by} \\ & \text{the SLIC at terminals TIPX and RINGX for a total two-wire} \\ & \text{impedance of } \mathsf{Z}_{\text{TR}} = \mathsf{Z}_{\text{TRX}} + 2\mathsf{R}_{\text{F}}. \end{split}$$

10

- 4. Normal polarity is defined as the tip lead being at a more positive potential than the ring lead. Reversed polarity is defined as the ring lead being at a more positive potential than the tip lead.
- 5. Higher return loss values can be achieved by adding a reactive component to R_{T} , the two-wire terminating impedance programming resistor, e.g. by dividing R_{T} into two equal halves and connecting a capacitor from the common point to ground. For $R_{T} = 60 \text{ k}\Omega$ the capacitance value is approximately 330 pF.
- 6. $V_{Bat} = -64$ V is applicable to the PBL 3798 in a 44-pin leaded chip carrier with the RSG terminal connected to the V_{EE} supply.
- 7. The overload level, V_{TXO} , is specified at the four-wire transmit port, VTX, with the signal source at the two-wire port. Note that the gain from the two-wire port to the four-wire transmit port is $G_{2\cdot4} = 1$.
- 8. The level is specified at the two-wire port.
- 9. The level is specified at the four-wire receive port (RSN).
- 10. Fuse resistors R_{F1} and R_{F2} impact the insertion loss as explained in the text, section Transmission. The specified insertion loss is for $R_{F1} = R_{F2} = 0 \Omega$.
- 11. The two-wire idle noise is specified with the port terminated in 600 Ω (R_L) and with the four-wire receive port grounded (E_{RX} = 0, E_L = 0; see figure 6).

The four-wire idle noise at VTX is specified with the twowire port terminated in 600 Ω (R_L). The four-wire receive port is grounded (E_{Rx} = 0, E_L = 0; see figure 6).

The idle channel noise degrades by approximately 5 dB when the saturation guard is active. Refer to section Battery feed for a description of the saturation guard.

12. These specifications are valid for a longitudinal impedance of 90 Ω and a metallic impedance of 135 Ω .

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- 13. Refer to section Battery Feed, Case 2.
- 14. Refer to Loop Monitoring Function, Loop current detectoractive state, Loop current detector - tip open state.
- 15. The loop current detector threshold hysteresis is a function of the $\rm R_{_D}$ value. Refer to note 14 above.
- 16. V_{ISat} is the voltage across the saturated transistor, i.e. between terminals VBAT and L.

Pin Description

- 17. Power supply rejection ratio test signal is 100 mVrms (sinusoidal).
- 18. Fuse resistor $R_{F1} = R_{F2} = 0$ ohm.
- R_{Gnd} resistance value less than the specified range will trigger the ground key detector, i.e. set the DET output to logic level low.
- 20. If a R_{sG} resistor is used in the 44-pin PLCC package, the specification with $R_{sG} \neq \infty$ is applicable.

PLCC: 44 pin and 32-pin, j-leaded chip carrier. DIP: 28-pin dual in-line. Refer to figure 11.

44PLCC	32PLCC	PDIP	Symbol	Description
1		—	NC	No internal connection. Note 1.
2	1	1	GND2	Ground. No internal connection to GND1. Note 2.
3	2	2	VREG	Regulated negative voltage for power amplifiers. The switch-mode regulator inductor, filter capacitor and RC stabilization network connect to this pin.
4	3	3	VCC	+5 V power supply.
5		—	NC	No internal connection. Note 1.
_	5	—	TP	TP is a thermal conduction pin tied to substrate (V _{QBat}). Note 3.
6	4	4	RINGRLY	Ring relay driver output. Sources up to 80 mA from VCC.
7	6	5	TESTRLY	Test relay driver output. Sources up to 80 mA from VCC.
8	7	6	L	Switch-mode regulator drive transistor output. The 1 mH inductor and the catch diode connect to this pin. These components must be connected with shortest possible lead lengths. The catch diode, including connecting leads, must exhibit a low inductance to clamp effectively, when the regulator switch opens.
9		—	NC	No internal connection. Note 1.
10	8	7	VBAT	Battery supply voltage. Negative with respect to GND2.
11	9	8	VQBAT	Quiet battery. An external filter capacitor connects between this pin and GND1 to provide filtered battery supply to signal processing circuits.
12	10	9	CHS	Switch-mode regulator stabilization network input. From this pin a capacitor connects to GND1 and a series RC network to VREG.
13	_	_	NC	No internal connection. Note 1.
14	11	10	CHCLK	Switch-mode regulator TTL compatible clock input. Nominal frequency: 256 kHz.
15	_	_	NC	No internal connection. Note 1.
16	12	11	C4	C1, C2, C3 and C4 are TTL compatible decoder inputs controlling the SLIC operating states.
17	13	12	E1	Detector select input. A logic high level enables the ground key detector. A logic low level enables the loop/ring-trip detector. TTL compatible input.
18	_	_	NC	No internal connection. Note 1.
19	14	_	E0	Detector output enable. A logic high level enables the $\overline{\text{DET}}$ output. A logic low level disables the $\overline{\text{DET}}$ output. TTL compatible input. The PBL 3798 in dual-in-line package has the $\overline{\text{DET}}$ output permanently enabled.
20	15	13	DET	Detector output. Inputs C1C3 and E1 select the detector to be connected to this output. When $\overline{\text{DET}}$ is enabled via E0 a logic low level indicates that the selected detector is tripped. The $\overline{\text{DET}}$ output is open collector with internal pull-up resistor (15 kohms) to VCC. When disabled, $\overline{\text{DET}}$ thus appears to be a resistor connected to V _{cc} .
21	16	14	C2	Refer to pin C4 description.
22	17	15	C3	Refer to pin C4 description.
23	18	16	C1	Refer to pin C4 description.
24	_	_	NC	No internal connection. Note 1

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44PLCC 25		edip ^{i.}	Symbol RSG	Description Saturation guard programming input. A resistor, R _{SG} , between pins RSG and VEE adjusts the saturation guard for operation with V _{Bat} from -64 V to -46 V. The PBL 3798 in dual- in-line and 32 pin surface mount package have the saturation guard internally set for operation
26	19	17	RDC	with $V_{Bat} = -48$ V. The constant dc loop current is programmed by two resistors connected in series from this pin to the receive summing node (RSN). The resistor junction point is decoupled to GND1 to filter noise and other disturbances before reaching the RSN input. V_{RDC} polarity is negative for normal tip-ring polarity and positive for reversed tip-ring polarity. $ V_{RDC} = 2.5V$ in the constant current region.
27	20&21	18	GND1	Ground. No internal connection to GND2. Note 2.
28	_	_	NC	No internal connection. Note 1.
29	22	19	RSN	Receive summing node. 100 times the current (dc and ac) flowing into this pin equals the metallic (transversal) current flowing between the TIPX and RINGX terminals. Programming networks for constant loop current, 2-wire impedance, and receive gain connect to the receive summing node.
30	_	_	NC	No internal connection. Note 1.
31	23	20	VEE	-5 V power supply.
32	24	21	VTX	Transmit vf output. The ac voltage difference between TIPX and RINGX, the ac metallic voltage, is reproduced as an unbalanced GND1 referenced signal at VTX with a gain of one. The two-wire impedance programming network connects between VTX and RSN.
33	_	_	NC	No internal connection. Note 1.
34	25	22	HPT	Tip side (HPT) of ac/dc separation capacitor.
35	26	23	HPR	Ring side (HPR) of ac/dc separation capacitor.
36	—	—	NC	No internal connection. Note 1.



Figure 11. Pin configuration, 44-pin and 32-pin j-leaded chip carrier and 28-pin dual-in-line package, Top view.

44PLCC 32PLCC PDIP Symbol			PDIP	Symbol	Description		
	37	27	24	RD	Loop current detector programming resistor, R_p , connects from RD to VEE. A filter capacitor C_p may be connected from RD to GND1.		
	38	28	25	DT	Inverting ring trip comparator input.		
	39	_	—	NC	No internal connection. Note 1.		
	_	29	—	TP	TP is a thermal conduction pin tied to substrate (V _{QBat}). Note 3.		
	40	30	26	DR	Non-inverting ring trip comparator input.		
	41	_	_	$TIPX_{Sense}$	TIPX _{Sense} is internally connected to TIPX. TIPX _{Sense} is used during manufacturing, but requires no connection in SLIC applications, i.e. leave open.		
	42	31	27	TIPX	The TIPX pin connects to the tip lead of the 2-wire line interface via overvoltage protection components, ring and test relays.		
	43	32	28	RINGX	The RINGX pin connects to the ring lead of the 2-wire line interface via overvoltage protection components, ring and test relays.		
	44	_	_	$RINGX_{_{Sense}}$	RINGX _{Sense} is internally connected to RINGX. RINGX _{Sense} is used during manufacturing, but requires no connection in SLIC applications, i.e. leave open.		
	NI 4						

Notes

- 1. Pins marked NC are not internally connected. It is recommended to ground these pins to provide shielding for sensitive terminals.
- 2. The GND1 and GND2 pins should be connected together via a direct printed circuit board trace.
- 3. For 32 pin PLCC, these pins (5 and 29) should be connected to V_{OBat}, serving as a heatsink.



Figure 12. PBL 3798 application example.

Functional Description and Applications Information Transmission

Overview

A simplified ac model of the transmission circuits is shown in figure 13. Neglecting the impact of the filters in figure 13 for frequencies from 300 Hz to 3.4 kHz (i.e. filter gain = 1), circuit analysis yields:

$$V_{TR} = V_{TX} + I_{L} \cdot 2R_{F}$$
(1)

$$\frac{V_{TX}}{Z_{T}} + \frac{V_{RX}}{Z_{RX}} = \frac{I_{L}}{100}$$
(2)

$$V_{TR} = E_{L} - I_{L} \cdot Z_{L}$$
(3)

where:

- V_{TX} is the ground referenced, unity gain version of the ac metallic (transversal) voltage between the TIPX and RINGX terminals, i.e. $V_{TX} = 1 \cdot V_{TRX}$.
- $V_{_{TR}}\;\;$ is the ac metallic voltage between tip and ring.
- E_L is the line open circuit ac metallic voltage.
- I, is the ac metallic current.
- R_F is the overvoltage protection current limiting resistor.
- Z_L is the line impedance.
- Z_{T} is the programming network for the TIPX to RINGX impedance.
- Z_{RX} controls the four-wire to two-wire gain.
- ${\rm V}_{_{\rm RX}}~$ is the analog ground referenced receive signal.

From equations (1), (2) and (3) expressions for two-wire impedance, two-wire to four-wire gain, four-wire to two-wire gain and four-wire to four wire gain may be derived.

Two-Wire Impedance

To calculate Z_{TR} , the impedance presented to the 2-wire line by the SLIC, including the resistors R_{F} , let $V_{RX} = 0$.

From (1) and (2):

$$Z_{TR} = \frac{Z_T}{100} + 2R_F$$

Since $Z_{_{TR}}$ and $R_{_{F}}$ are known $Z_{_{T}}$ may be calculated from

$$Z_{T} = 100 \bullet (Z_{TP} - 2R_{E})$$

Example: calculate $Z_{_{T}}$ to make the terminating impedance $Z_{_{TR}}$ = 900 Ω in series with 2.16 μ F. R_{_{F}} = 40 $\Omega.$

Using the expression above

$$Z_{T} = 100 \cdot (900 + \frac{1}{j\omega \cdot 2.16 \cdot 10^{-6}} - 2 \cdot 40)$$
$$= 82 \cdot 10^{3} + \frac{1}{j\omega \cdot 21.6 \cdot 10^{-9}}$$

i.e. $Z_{T} = 82 \Omega$ in series with 21.6 nF. It is always necessary to have a high ohmic resistor in parallel with the capacitor. This gives a DC-feedback loop for low frequency which ensure stability and reduces noise.

Two-Wire to Four-Wire Gain

The two-wire to four-wire gain, $\rm G_{_{2\mbox{-}4}},\, can$ be obtained from (1) and (2) with

$$V_{RX} = 0:$$

 $G_{2.4} = \frac{V_{TX}}{V_{TR}} = \frac{Z_T / 100}{Z_T / 100 + 2R_F}$

Four-Wire to Two-Wire Gain

The four-wire to two-wire gain, G_{4-2} , is derived from (1), (2) and (3) with $E_1 = 0$:

$$G_{4-2} = \frac{V_{TR}}{V_{RX}} = -\frac{Z_T}{Z_{RX}} \cdot \frac{Z_L}{Z_T/100 + 2R_F + Z_L}$$

Four-Wire to Four-Wire Gain

The four-wire to four-wire gain, G_{4-4} , is derived from (1), (2) and (3) with $E_L = 0$: $G_{4-4} = \frac{V_{TX}}{V_{RX}} = -\frac{Z_T}{Z_{RX}} \cdot \frac{Z_L + 2R_F}{Z_T/100 + 2R_F + Z_L}$

Hybrid Function

The PBL 3798 SLIC forms a particularly flexible and compact line interface when used together with Siemens Codec Filter circuit (SiCoFi) or other similar programmable CODEC/filter. The SiCoFi allows for system controller adjustment of hybrid balance to accommodate different line impedances without change of hardware. The SiCoFi also permits the system controller to adjust transmit and receive gains as well as terminating impedance. Refer to SiCoFi or similar programmable CODEC/filter data sheets for design information.



Figure 13. Simplified ac transmission circuit.



Figure 14. Hybrid function.

The hybrid function in an implementation utilizing the uncommitted amplifier in a conventional CODEC/filter combination is shown in figure 14. Via impedance $Z_{\rm B}$ a current proportional to $V_{\rm RX}$ is injected into the summing node of the combination CODEC/filter amplifier. As can be seen from the expression for the four-wire to four-wire gain a voltage proportional to $V_{\rm RX}$ is returned at VTX. This voltage is converted by $R_{\rm TX}$ to a current flowing into the same summing node. These currents can be made to cancel each other by letting:

$$\frac{V_{TX}}{R_{TX}} + \frac{V_{RX}}{Z_{B}} = 0$$
 (E_L = 0)

Substituting the four-wire to four-wire gain expression, G_{4-4} , for V_{RX}/V_{TX} yields the formula for the balance network:

$$\begin{split} Z_{\rm B} &= - \, {\rm R}_{\rm TX} \bullet \frac{{\rm V}_{\rm RX}}{{\rm V}_{\rm TX}} = \\ &= {\rm R}_{\rm TX} \bullet \frac{{\rm Z}_{\rm RX}}{{\rm Z}_{\rm T}} \bullet \frac{{\rm Z}_{\rm T}/100 + 2{\rm R}_{\rm F} + {\rm Z}_{\rm L}}{{\rm Z}_{\rm L} + 2{\rm R}_{\rm F}} \\ &= {\rm Example:} \, {\rm Z}_{\rm TR} = {\rm Z}_{\rm L} = 900 \, \Omega({\rm R}_{\rm L}) \, {\rm in} \\ {\rm series \ with \ 2.16 \ \mu F \ ({\rm C}_{\rm L}) \, {\rm R}_{\rm F} = 40 \ \Omega}, \\ {\rm R}_{\rm TX} &= 27.4 \ {\rm k}\Omega, \, {\rm G}_{\rm 4-2} = -1. \ {\rm Calculate} \ {\rm Z}_{\rm B}. \\ &= {\rm Using \ the} \ {\rm Z}_{\rm B} \ {\rm formula \ above:} \\ {\rm Z}_{\rm B} = \{{\rm Z}_{\rm L} = {\rm Z}_{\rm TR}\} = {\rm R}_{\rm TX} \bullet \frac{{\rm Z}_{\rm RX}}{{\rm Z}_{\rm T}} \bullet \frac{{\rm 2Z}_{\rm L}}{{\rm Z}_{\rm L} + 2{\rm R}_{\rm F}} \end{split}$$

$$= \{G_{4\cdot 2} = -1\} = R_{TX} \bullet \frac{Z_L}{Z_L + 2R_F} =$$
$$= R_{TX} \bullet \frac{1 + j\omega \bullet R_L \bullet C_L}{1 + j\omega \bullet (R_L + 2R_F) \bullet C_L}$$

A network consisting of R_{B1} in series with the parallel combination of R_{B} and C_{B} has the same form as the required



Figure 15. Longitudinal feedback loop. $V_{LoRef} = (V_{Tip} + V_{Ring})/2$ (without any longitudinal voltage component).



Figure 16. Battery feed.

balance network, Z_B. Basic algebra

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$$R_{B1} = R_{TX} \bullet \frac{R_{L}}{R_{L} + 2R_{F}} = 25.2 \text{ k}\Omega$$

$$R_{B} = R_{TX} \bullet \frac{2R_{F}}{R_{L} + 2R_{F}} = 2237 \Omega$$

$$C_{B} = \frac{(R_{L} + 2R_{F})^{2} \bullet C_{L}}{R_{TX} \bullet 2R_{F}} = 0.95 \,\mu\text{F}$$

Longitudinal Impedance

vields:

A feedback loop counteracts longitudinal voltages at the two-wire port by injecting longitudinal currents in opposing phase. Therefore longitudinal disturbances will appear as longitudinal currents and the TIPX and RINGX terminals will experience very small longitudinal voltage excursions well within the SLIC common mode range. This is accomplished by comparing the instantaneous two-wire longitudinal voltage to an internal reference voltage, $V_{{\scriptscriptstyle LoRef}}$. As shown below, the SLIC appears as 20 Ω to ground per wire to longitudinal disturbances. It should be noted, that longitudinal currents may exceed the dc loop current without disturbing the vf transmission. From figure 15 the longitudinal impedance can be calculated:

$$\frac{V_{Lo}}{I_{Lo}} = \frac{R_{Lo}}{100} = 20 \Omega$$

where:

 V_{Lo} is the longitudinal voltage

I₁₀ is the longitudinal current

 $R_{Lo} = 2 \ k\Omega$ sets the longitudinal impedance

Capacitors C_{TC} and C_{RC}

The capacitors designated $\mathbf{C}_{_{TC}}$ and $\mathbf{C}_{_{RC}}$ in figure 12, connected between TIPX and ground as well as between RINGX and ground, are recommended as an addition to the overvoltage protection network. Very fast transients, appearing on tip and ring, may pass by the overvoltage pro-tection network, before this device has had time to activate and could damage the SLIC. C_{TC} and C_{RC} short such very fast transients to ground. The recommended value for C_{TC} and C_{RC} is 2200 pF. Higher capacitance values may be used, but care must be taken to prevent degradation of either longitudinal balance or return loss. C_{TC} and C_{RC} contribute a metallic impedance of $1/(\pi \cdot f \cdot C_{TC}) \approx 1/(\pi \cdot f \cdot C_{RC})$, a TIPX to ground impedance of $1/(2 \cdot \pi \cdot f \cdot C_{TC})$



and a RINGX to ground impedance of $1/(2 \cdot \pi \cdot f \cdot C_{RC})$.

Ac - dc Separation Capacitor

The high pass filter capacitor connected between terminals HPT and HPR provides separation between circuits sensing TIPX-RINGX dc conditions and circuits processing vf signals. The recommended $C_{\rm HP}$ capacitance value of 220 nF will position the 3 dB break point at 1.8 Hz.

Battery Feed

Overview

The PBL 3798 SLIC synthesizes a constant current feed system without the disadvantage of high feed circuit power dissipation on short loops. To reduce power dissipation a switch mode regulator efficiently down-converts the battery supply voltage. The down-converted voltage is applied to the line drive amplifiers and is automatically adjusted to be precisely enough to feed the loop current as well as to allow distortion free vf signal transmission.

The magnitude of the constant loop current is set by two external resistors.

The battery feed polarity can be set to either normal or reversed polarity via the SLIC digital control inputs.

To permit the line drive amplifiers to operate without signal distortion even on high resistance or open circuit loops, a saturation guard circuit limits the loop voltage, when the tip to ring dc voltage approaches the available battery supply voltage.

With the SLIC set to the stand-by state, power is further conserved by

Figur 17. PBL 3798 battery feed $R_{DC1} = R_{DC2} = 3,125 \text{ k}\Omega, I_{Ldc} = 40 \text{mA}.$

Curve ABE: active state. PBL 3798 in 28-pin DIP, 32 pin or 44-pin PLCC with $R_{SG} = \infty \Omega$ and $V_{Bar} = -48V$.

Curve ACD: active state. PBL 3798 in 44-pin PLCC with R_{sg} = 0 Ω and V_{sat} = -63V.

Curve FGJ: stand-by state. PBL 3798 in 28-pin DIP, 32-pin or 44-pin PLCC with $R_{sG} = \infty \Omega$ and $V_{Bat} = -48V$.

Curve FHI: stand-by state. PBL 3798 in 44-pin PLCC with R_{sg} = 0 Ω and V_{Bat} = -63V. limiting the short circuit loop current to 50% of the active state short circuit current.

The following paragraphs describe the battery feed circuit in detail. At the end of this section a paragraph, Battery feed circuit programming procedure, summarizes the few simple calculations necessary to program the battery feed.

Case 1: SLIC in the Active or Active Polarity Reversal State; $|V_{TRdc}| < V_{SGRef}$, $|V_{Bat}| > V_{SGRef} + 12 V$

In the active state C3, C2, C1 = 0, 1, 0 and in the active polarity reversal state C3, C2, C1 = 1, 1, 0.

The battery feed control loop is shown in block diagram form in figure 16. For tip to ring dc voltages less than the saturation guard reference voltage, V_{SGRef} (refer to case 2) the following expression is obtained from the block diagram for $R_F=0$. 250

$$I_{Ldc} = p \bullet \frac{250}{R_{DC1} + R_{DC2}}$$

where:

I ude is the constant dc loop current

 R_{DC1} , R_{DC2} are the external constant current programming resistors

p = 1 for normal polarity, -1 for reversed polarity

In figure 17, curve segment AB (DIP 32 pin or 44 pin PLCC or AC 44 pin PLCC is described by case 1.

Case 2: SLIC in the Active or Active Polarity Reversal State;

 $|V_{TRdc}| > V_{SGRef}$, $|V_{Bat}| > V_{TRdc}+12V$ In the active state C3, C2, C1 = 0, 1, 0 and in the active polarity reversal state C3, C2, C1 = 1, 1, 0.

When the tip to ring dc voltage approaches the V_{Bat} supply voltage, a circuit named saturation guard limits the two wire voltage to a small additional increase beyond the saturation guard threshold, V_{SGRef} . This is to maintain distortion free vf transmission through the line drive amplifiers. The saturation guard feature makes on-hook transmission possible.

The tip to ring voltage at which the saturation guard becomes active, $\rm V_{\rm SGRef},$ can be calculated from

$$V_{SGRef} = \frac{34,1}{1-\frac{0,676}{R_{SG}+2,26}}$$

where $V_{_{SGRef}}$ is in volts for $R_{_{SG}}$ in $k\Omega.$ $R_{_{SG}}$ is a resistor connected between terminal RSG and -5V.

Note that the RSG terminal is availible only on the 44-pin surface mount package. The 28-pin dual-inline and 32-pin surface mount package have the saturation guard internally set to $V_{sGRef} = 34.1V$.

 $\label{eq:sg} \begin{array}{l} {\sf R}_{{\rm SG}} = \mbox{ open circuit yields } {\sf V}_{{\rm SGRef}} = 34.1{\sf V}. \\ {\sf R}_{{\rm SG}} = 0 \ \Omega \mbox{ yields } {\sf V}_{{\rm SGRef}} = 48.6{\sf V}. \end{array}$

The loop current, I_{Ldc} , as a function of the loop voltage, V_{TRdc} , for $V_{TRdc} > V_{SGRef}$ is described by

$$I_{Ldc} = \frac{V_{SGRef} - V_{TRdc}}{120} + \frac{250}{R_{DC1} + R_{DC2}}$$

The open circuit voltage is then, for a programmed loop current of 40mA, 38.9V for R_{sg} = open circuit and 53.4V for R_{sg} = 0 Ω .





In figure 17, PBL 3798 battery feed examples, curve segment CD and BE are described by case 2.

Case 3: SLIC in the stand-by or standby polarity reversal state;

 $|V_{_{TRdc}}| < V_{_{SGRef}}$, $|V_{_{Bat}}| > V_{_{SGRef}}$ + 12 V The stand-by operating states reduce power dissipation.

The loop feed in the stand-by state (C3, C2, C1 = 0, 1, 1) and in the standby polarity reversal state (C3, C2, C1 = 1, 1, 1) is constant current according to:

$$I_{Ldc} = p \bullet \frac{125}{R_{DC1} + R_{DC2}}$$

In figure 17, PBL 3798 battery feed examples, this corresponds to curve segments FG and FH.

Case 4: SLIC in the Stand-By or Stand-By Polarity Reversal State;

 $|V_{TRdc}| > V_{SGRef}, |V_{Bat}| > V_{SGRef} + 12V$ In the stand-by state C3, C2, C1 = 0, 1, 1 and in the stand-by polarity reversal state C3, C2, C1 = 1, 1, 1.

When the tip to ring dc voltage exceeds the saturation guard reference voltage, V_{SGRef} , the loop feed is described by

$$I_{Ldc} = \frac{V_{SGRef} - V_{TRdc}}{120} + \frac{125}{R_{DC1} + R_{DC2}}$$

In figure 17, this corresponds to curve segments HI and GJ.

Case 5: SLIC in the TIPX Open Circuit State.

In the TIPX open circuit state C3, C2, C1 = 1, 0, 0. Refer to figure 8. In this state the TIPX terminal is set to a highimpe-dance state (> 150 k Ω). The RINGX terminal sinks a current $(|I_{LRTo}| > 23 \text{ mA until the } V_{Bat} \text{ voltage is}$ approached, whereafter the RINGX terminal changes to a constant voltage state and the RINGX current can be calculated from:

$$|I_{LRTo}| = \frac{|V_{Bat} + 4|}{R_{LRGnd}}$$

where:

R_{LRGnd} is the resistor between ground and ring lead.

C_{DC} Capacitor

Refer to the battery feed block diagram, figure 16. The battery feed programming resistors R_{DC1} and R_{DC2} together with capacitor C_{DC} form a low pass filter, which removes noise and vf signals from the battery feed control loop. The recommended 3 db break point frequency is 160 Hz < f_{3dB} < 240 Hz. The C_{pc} capacitance value is then calculated from:

$$C_{DC} = \frac{1}{2\pi \cdot f_{3dB}} \cdot \left[\frac{1}{R_{DC1}} + \frac{1}{R_{DC2}} \right]$$

Note that $R_{DC1} = R_{DC2}$ yields minimum C_{DC} capacitance value.



Figure 18. Switch mode regulator.

Switch Mode Regulator

The switch mode regulator downconverts the $V_{\mbox{\tiny Bat}}$ supply voltage to a value, which is just enough for the line drive amplifiers to feed the required loop current and maintain transmission quality. Since the voltage conversion efficiency is high and the minimum required voltage drop across the line drive amplifiers is low, a significant power dissipation reduction is realized. A 50 mA constant current feed with 200 Ω line resistance and -48 V battery will have 1.9 W dissipated in the line feed circuit. The PBL 3798 set up for the same 50 mA constant current feed and with the same 200 Ω line resistance and V_{Bat} = -48 V, would generate only 0.72 W in the line feed circuits (90% power conversion efficiency), i.e. a 1.18 W or 62.1% reduction in line card power dissipation.

Refer to figure 18 for a block diagram of the switch mode regulator. $V_{\scriptscriptstyle Bat}$ is the input voltage, which the regulator converts to V_{Reg} with high efficiency. V_{Reg} powers the line drive amplifiers. The switch mode regulator adjusts its V_{Reg} output to be equal to the reference voltage, V_{Ref} . The reference voltage is derived from the TIPX to RINGX dc metallic voltage according to

 $V_{Ref} = -(|V_{TRdc}| + V_{Bias})$

where $V_{_{Bias}}$ is approximately 12 V. Since $V_{_{Bias}}$ is the voltage drop across the line drive amplifiers, the SLIC power loss is greatly reduced compared to supplying the amplifiers directly from the V_{Bat} supply.

The battery supply voltage, |V_{Bat}|, must be larger than $|V_{_{Reg}}|, \, i.e. \, |V_{_{Bat}}| \geq |V_{_{TRdc}}|$ + V_{Bias}. If this condition is not met, the tip to ring voltage will be limited by the SLIC according to $|V_{TRdc}| = |V_{Bat}| - V_{Bias}$. Although the SLIC continues to function, this mode of operation should be avoided due to increased noise and a much reduced V_{Bat} to transmission ports rejection ratio.

To minimize noise as well as battery feed circuit power dissipation on long loops the switch mode regulator is automatically turned off for tip to ring dc voltages exceeding a threshold value of approximately V_{SGRef} - 1V. With the regulator disabled, the V_{Bat} supply voltage is passed on to the VREG input without being down-converted.

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The inductor, L, should be 1 mH with a series resistance larger than 15 Ω . A saturated inductor with less than 15 Ω of series resistance may damage the SLIC due to excessive regulator switch current.

 $C_{_{Fit}}$ 0.47 $\mu F,$ is the regulator output filter capacitor.

The catch diode, D_1 , (e.g.1N4448) must withstand 70 V reverse voltage, conduct an average of 50 mA (150 mA peak) and turn off in less than 10 nsec.

 C_{CH1} , C_{CH2} and R_{CH} make up a compensation network for an internal voltage comparator. Values are given in the applications example, figure 12.

The components associated with the switching regulator must be connected via the shortest possible PCB trace lengths. Other circuits should be kept isolated from this area. The L terminal voltage variations are large and very fast. To avoid interference the inductor and the catch diode should be located directly at this terminal. Inductors with closed magnetic path core (e.g. toroid, pot core) will reduce interference originating from the inductor.

Battery Feed Circuit Programming Procedure

Extracting the key elements from the preceeding description results in the following step-by-step procedure.

1. Establish the battery feed requirements.

Constant loop current, $I_{Ldc} = ?$

Maximum loop resistance, including fuse resistors R_{F1} and R_{F2} , $R_{LMax} = ?$ Loop resistance, above which it is permissible for the loop feed to change from constant current feed to

resistive feed, R_{LSGRef} = ?

Loop current at the maximum loop resistance

(applies if I_{Ldc} • R_{LMax}> V_{SGRef}) I_{LMin} = ? SLIC supply voltage, V_{Bat} = ?

2. Calculate the constant current programming components $R_{_{DC1}}$ and $R_{_{DC2}}$ from

$$R_{DC1} = R_{DC2} = \frac{250}{I_{Ldc}} \cdot \frac{1}{2}$$

3. Calculate C_{DC} from

$$C_{DC} = \frac{1}{2\pi \cdot f_{3dB}} \cdot \left[\frac{1}{R_{DC1}} + \frac{1}{R_{DC2}}\right]$$

where $f_{_{3dB}}\approx 200~Hz$

 4. Calculate the saturation guard programming resistor, R_{sg}.
 PBL 3798 in 28-pin dual-in-line and 32-pin surface mount package:

No RSG terminal provided. V_{SGRef} is internally set to 34.1V. The minimum required battery voltage is $|V_{Batmin}| = V_{SGRef}$ +12 V. For loop voltages greater than V_{SGRef} ,

 $|V_{\text{Batmin}}| = V_{\text{TRdc}} + 12 \text{ V}.$

PBL 3798 in 44-pin surface mount package:

RSG terminal open circuit:

 R_{SG} terminal shorted to V_{EE} : $V_{SGRef} = 48.6V.$

For intermediate $V_{_{SGRef}}$ values calculate $R_{_{SG}}$ according to

$$R_{SG} = - \frac{1,59}{1 + \frac{14,5}{V_{SGRel} - 48,6}}$$

where R_{SG} is in k Ω for V_{SGRef} in volts. The minimum required battery voltage is $|V_{Batmin}| = V_{SGRef} + 12$ V. For loop voltages greater than V_{SGRef} , $|V_{Batmin}| = V_{TPdr} + 12$ V.

5. Calculate the loop resistance at which the saturation guard becomes active, R_{LSGRef} :

$$R_{LSGRef} = \frac{V_{SGRef}}{I_{Ldc}}$$

Confirm compatibility with requirements.

6. If I_{Ldc} • R_{LMax} > V_{SGRef}, calculate loop current at maximum loop resistance:

$$V_{SGRef} + 120 \bullet \frac{250}{R_{DC1} + R_{DC2}}$$

 $I_{Ldc min} = \frac{120 + R_{LMax}}{120 + R_{LMax}}$

Confirm compatibility with requirements.

 Recommended switch mode regulator component values:
 I = 1 mH + 10 %⁻

$$C_{FH} = 0.47 \ \mu F \pm 10\%, \ 100 \ V;$$

 $D_1 = 1N4448$ (or equivalent),

- $R_{CH} = 909 \ \Omega \pm 2\%, \ 0.25 \ W;$
- $C_{_{CH1}} = 0.047 \ \mu F \pm 10\%, \ 100 \ V;$
- $C_{_{CH2}}$ = 1500 pF ± 10%, 100 V.

Loop Monitoring Functions

Overview

The PBL 3798 SLIC contains three detectors: the loop current, the ground key and the ring trip detector. These three detectors report their status via the shared $\overline{\text{DET}}$ output. The detector to be connected to the DET output is selected according to the logic states at the control inputs C1, C2, C3 and enable input E1. Enable input E0 (available only on the 32 pin and 44-pin surface mount packages) sets the DET output to either active or high impedance state.

Loop Current Detector - Active State and Standby State

Active state (C3, C2, C1 = 0, 1, 0) and active polarity reversal state (C3, C2, C1 = 1, 1, 0) as well as standby state (C3,C2, C1 = 0, 1,1) and standby polarity reversal state (C3, C2, C1 = 1, 1, 1).

The loop current value at which the loop current detector changes state is programmable by calculating a value for resistor $R_{\rm D}$. $R_{\rm D}$ connects between terminals RD and VEE.

Figure 19 shows a block diagram for the loop current detector. The two-wire interface produces a current, I_{RD} , flowing out of pin RD:

$$I_{RD} = 0.5 \bullet \frac{|I_{LT} - I_{LR}|}{300} = \frac{|I_{L}|}{300}$$

where I_{LT} and I_{LR} are currents flowing into the TIPX and RINGX terminals and I_{L} is the loop current. The voltage generated across the programming resistor R_{D} by I_{RD} is applied to an internal comparator with hysteresis. The comparator reference voltage for transition on-hook to off-hook is 1.55 V. The reference voltage for a transition off-hook to onhook is 1.37 V. A logic low level results at the DET output, when the comparator reference voltage is exceeded.

For a specified on-hook to off-hook loop current threshold, $I_{\text{LThOff}},\,R_{\text{D}}$ is calculated from

$$\mathsf{R}_{\mathsf{D}} = \frac{1.55 \bullet 300}{|\mathsf{I}_{\mathsf{LThOff}}|}$$

The calculated $R_{\rm D}$ value corresponds to an off-hook to on-hook loop current threshold, $I_{\rm LThOn}$, of

$$|I_{LThOn}| = \frac{1.37 \cdot 300}{R_{D}}$$

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Loop Current Detector - Tip Open Circuit State

Tip open circuit state (C3, C2, C1 = 1, 0, 0)

In the tip open circuit state the loop current detector function is similar to the active state, but the RD terminal current, I_{RD} , is calculated from

 $I_{RD} = \frac{I_{LR}}{600}$ where I_{LR} is the ring lead current.

The detector is triggered at a ring lead threshold current $I_{LRThOffTo}$ with the R_D resistance value set to

$$R_{\rm D} = \frac{1.55 \cdot 600}{I_{\rm LRThOffTo}}$$

$$I_{LRThOnTo} = \frac{1.37 \cdot 600}{R_{p}}$$

t

for the detector to return to its non-triggered state.

Loop Current Detector - Filter Capacitor

To increase the loop current detector noise immunity, a filter capacitor may be added from terminal RD to ground. A suggested value for C_{p} is:

$$C_{D} = \frac{1}{2\pi \bullet R_{D} \bullet f_{3dB}}$$

where

 $f_{_{3dB}}$ = 500 Hz is the high end frequency response 3dB break point for the low pass filter created.

 C_{p} is in farads for R_{p} in Ω .

Note that $C_{_D}$ may not be required if the detector output is software filtered.

Ground Key Detector

Refer to figure 19 for a block diagram of the ground key detector. The ground key detector examines the difference between TIPX and RINGX currents. When the longitudinal current from ground exceeds an internally set threshold value of nominally 8 mA, the detector triggers and



Figure 19. Loop current and ground key detector.



ringing.

Figure 20. Ring trip network, balanced



sets the DET output to a logic low level. The E1 enable input must be set to logic high level to gate the ground key detector to the DET output. The Electrical characteristics table specifies the threshold level as a function of longitudinal resistance to ground.

The ground key detector threshold is pre-programmed and cannot be changed by external components.

Ring Trip Detector

Ring trip detection is accomplished by monitoring the two-wire line for presence of dc current while ringing is applied. When the subscriber goes off-hook with ringing applied, dc loop current starts to flow. The comparator in the SLIC with inputs DT and DR detects this current flow via an interface network. The result of the comparison is presented at the DET output. The ring trip comparator is automatically connected to the DET output, when the SLIC control inputs are set to the ringing state (C3, C2, C1 = 0, 0, 1). When off-hook during ringing is detected, the line card or system controller will proceed to disconnect the ringing source (software ringtrip) by resetting the control input logic states. Alternatively, the DET output may be monitored by circuits on the line card, which perform the ringtrip function (hardware ringtrip).

The ringing source may be balanced or unbalanced, superimposed on the V_{Bat} supply voltage. The unbalanced ringing source may be applied to either the tip

lead or the ring lead with return on the other wire. A ring relay, energized by the SLIC ring relay driver, connects the ringing source to tip and ring. For unbalanced ringing systems the loop current sensing resistor may be placed either in series with the ringing generator or in series with the return lead to ground.

Figures 20 and 21 show examples of balanced and unbalanced ringing systems. For either ringing system the ringtrip detection function is based on a polarity change at the inputs DT and DR of the ringtrip comparator.

In the unbalanced case the dc voltage drop across resistor $\mathrm{R}_{_{\mathrm{RT}}}$ is zero as long as the telephone remains on-hook. With the telephone off-hook during ringing, dc loop current will flow, causing a voltage drop across R_{RT} . The R_{RT} voltage is applied to the comparator input DT via resistor R₂. R₄ shifts the voltage level to be within the comparator common mode range. $\mathbf{C}_{_{\!\!\mathsf{RT}}}$ removes the ac component of the ringing signal. R₁ and R₂ establish a bias voltage at comparator input DR, which is more negative than DT when the telephone is on-hook and is more positive than DT when the telephone goes off-hook during ringing.

Complete removal of the ringing signal ac component at the DT input may not be necessary. Some residual ac component at the DT input may under <u>certain operating conditions cause the</u> DET output to toggle between the onhook and off-hook states at the ringing frequency. However, with the telephone off-hook the DET output will be at logic low level for more than half the time. Therefore, by sampling the DET output, a software routine can discriminate between on-hook and off-hook through examination of the duty cycle. Full removal of the ringing frequency from the DT input while maintaining ringtrip within required time limits (approximately < 100 ms) usually mandates a second order filter rather than the first order shown in figure 21. The software approach minimizes the number of line card components.

In the balanced ringing system shown in figure 20, R₁ and R₂ are the loop current sensing resistors. With the telephone on-hook, no dc loop current flows to cause a dc voltage drop across resistors R₁ and R₂. Voltage dividers R_{B2}, R₄ and R_{B1}, R₃ bias the ringtrip comparator input DT to be more positive than DR. With the telephone off-hook during ringing dc loop current will flow, causing a voltage drop across resistors R, and R₂, which in turn will make comparator input DT more negative than DR, setting the DET output to logic low level, indicating ringtrip condition. Capacitors $C_{\rm RT1}$ and $C_{\rm RT2}$ filter the ring voltage at the comparator inputs. For 20 Hz ringing it is suitable to calculate these capacitors for a time constant of T = 50 ms, i. e.

$$C_{RT1} = T \cdot \left(\frac{1}{R_{B2}} + \frac{1}{R_4}\right)$$



Figure 21. Ring trip network, unbalanced ringing.



Detector Output, DET

The loop current detector, ground key detector and ringtrip comparator share a common output, DET. The DET output is open collector with internal pull-up resistor to V_{cc} . Via control inputs C1 through C3 and enable input E1 one of the three detectors is selected to be connected to the DET output. With enable input E0 set to logic high level the DET output is activated. In the DET active state a logic low level indicates a triggered detector condition and a logic high level reports a non-triggered detector. With E0 set to logic low level, the DET output is set to its high impedance state, i.e. connected to V_{cc}

via the internal pull-up resistor. Note that the DET high impedance state is available only on the 32-pin and 44-pin surface mount package.

Relay Drivers

The PBL 3798 SLIC contains two identical drivers for test and ring relays. The drivers are pnp transistors in open collector configuration, sourcing up to 80 mA from the V_{cc} supply. Each driver has an internal inductive kick-back clamp diode. The relay coil may be connected to negative supply voltages ranging from ground to V_{Bat} . Control input C4 activates the test relay driver. Control inputs C1, C2 and C3 are used to operate the ring relay.

State #	C4 Note	C3 e 1	C2	C1	Operating State	Active detector Note 2
1	Х	0	0	0	Open circuit	Ring trip comparator
2	Х	0	0	1	Ringing	Ring trip comparator
3	Х	0	1	0	Active	Loop current or ground key
4	Х	0	1	1	Stand-by	Loop current or ground key
5	Х	1	0	0	Tip open	Loop current, Note 3
6	Х	1	0	1	Reserved	None
7	Х	1	1	0	Active polarity reversal	Loop current or ground key
8	Х	1	1	1	Stand-by polarity reversal	Loop current or ground key

Notes

- 1. Control input C4 logic state (X) affects only the test relay driver and does not change the SLIC operating state. C4 at logic low level activates the test relay driver. C4 at logic high level turns the test relay driver off.
- 2. Enable input E1 must be set to select between loop current and ground key detector.
- 3. The ground key detector is not functional in the tip open circuit state

Table 1. PBL 3798 operating states.

Enable state #	E0 Not	E1 e 1	DET output state	Active detector
1	0	Х	High impedance	None
2	1	0	Active	Loop current or ringtrip. Note 2
3	1	1	Active	Ground key

Notes

- 1. Enable input E0 is available only on the 32 pin and 44-pin surface mount package option. In the 28 pin dual-in-line package the DET output is set to active state.
- 2. The loop current detector or the ring trip comparator is selected via C3, C2, C1 (state# 2 selects the ringtrip comparator.

Table 2. Enable inputs E0 and E1.

Overview

The PBL 3798 SLIC has four TTL compatible control inputs, C1 through C4. A decoder in the SLIC interprets the control input logic conditions and sets up the commanded operating state. C1 through C3 allow for eight operating states. The C4 control input acts directly on the test relay driver.

The control inputs interface with programmable CODEC/filters, e.g. SLAC, SiCoFi, Combo II without any interface components. Via serial I/O ports on the programmable CODEC/ filter devices a microprocessor can communicate with the SLIC. In designs utilizing conventional CODEC/filters without control latches, the line card logic must contain the neccessary latches for inputs C1 through C4.

Table 1 contains a summary description of the Control Inputs.

Test Relay Control (C4)

With C4 set to logic low level the test relay driver (TESTRLY) is activated. The active driver can source up to 80 mA from the V_{cc} supply. C4 set to logic high level causes the relay driver to be deenergized. The test relay driver is controlled exclusively by C4 and is independent of the C1, C2 and C3 logic levels.

Open Circuit State (C3, C2, C1 = 0, 0, 0)

In the Open Circuit State both the TIPX and RINGX power amplifiers present a high impedance to the line. The loop current and ground key detectors are not active in this state.

Ringing State (C3, C2, C1 = 0, 0, 1)

The ring relay driver (RINGRLY) is activated and the ring trip comparator is connected to the detector output (DET). The TIPX and RINGX terminals are in the high impedance state and signal transmission is inhibited.

Active State (C3, C2, C1 = 0, 1, 0)

TIPX is the terminal closest to ground potential and sources loop current, while RINGX is the more negative terminal and sinks loop current. Signal transmission is normal and the loop current or ground key detector is gated to the DET output according to enable input E1 logic state.

Stand-by State (C3, C2, C1 = 0, 1, 1)

In the stand-by state the short circuit loop current is reduced to:

 $I_{Ldc} = 125 / (R_{DC1} + R_{DC2}).$

The loop current or ground key detector is connected to the $\overline{\text{DET}}$ output in accordance with the E1 input logic state.

TIPX Open Circuit State (C3, C2, C1 = 1, 0, 0)

The TIPX power amplifier presents a high impedance to the line. The RINGX terminal is active and sinks current. The loop current detector is connected to the DET output for enable input E1 = 0. The detection threshold for the on-hook to off-hook transition is $I_{LRThOffTo} = (1.55 \cdot 600) / R_{D}$. For E1 = 1 the ground key detector is connected to the DET output. Note that the ground key detector is not functional in the tip open circuit state.

Reserved State (C3, C2, C1 = 1, 0, 1)

This state has no assigned function.

Active Polarity Reversal State (C3, C2, C1 = 1, 1, 0)

TIPX and RINGX polarity is reversed from the Active State: RINGX is the terminal closest to ground and sources loop current while TIPX is the more negative terminal and sinks current. Polarity reversal transition time is 4 msec. The loop current or ground key detector is connected to the DET output in accordance with the E1 input logic state. Signal transmission is normal.

Stand-by Polarity Reversal State (C3, C2, C1 = 1, 1, 1)

Polarity Reversal as described under state C3, C2, C1 = 1, 1, 0 and Stand-by as described under state C3, C2, C1 = 0, 1, 1.

Enable Inputs

The 44-pin and 32-pin surface mount package version of the PBL 3798 SLIC has two TTL compatible enable inputs, E0 and E1. The 28 pin dual-in-line package version of the PBL 3798 has one enable input, E1.

E0 sets the DET output to active state, when at logic high level and to high impedance state when at logic low level. E1 selects the loop current detector to be gated to the DET output, when at logic low level and the ground key detector when at logic high level. Table 2 summarizes the above description of the Enable Inputs.

Overvoltage Protection

The PBL 3798 SLIC must be protected against overvoltages on the telephone line caused by lightning, ac power contact and induction. Refer to Maximum Ratings, TIPX and RINGX terminals, for maximum allowable continuous and transient voltages that may be applied to the SLIC. The circuit shown in figure 12 utilizes series resistors together with a pro-grammable overvoltage protector (e g Texas Instrument TISP PBL 1), serving as a secondary protection. The protector network in figure 12 is designed to meet requirements in ITU-T k20, table 1. The TISP PBL 1 is a dual forwardconducting buffered p-gate overvoltage protector. The protector gate references the protection (clamping) voltage to negative supply voltage (i e the battery voltage, V_{Bat}). As the protection voltage will track the negative supply voltage the overvoltage stress on the SLIC is minimized.

Positive overvoltages are clamped to ground by an internal diode. Negative overvoltages are initially clamped close to the SLIC negative supply rail voltage. If sufficient current is available from the overvoltage, then the protector will crowbar into a low voltage on-state condition, clamping the overvoltage close to ground.

A gate decoupling capacitor, C_{TISP} is needed to carry enough charge to supply a high enough current to quickly turn on the thyristor in the protector. Without the capacitor even the low inductance in the track to the V_{Bat} supply will limit the current and delay the activation of the thyristor clamp. The fuse resistors R_F serve the dual purposes of being non- destructive energy dissipators, when transients are clamped and of being fuses, when the line is exposed to a power cross. Ericsson Components AB offers a series of thick film resistors networks (e g PBR 51series and PBR 53-series) designed for this application.

Also devices with a built in resetable fuse function is offered (e g PBR 52series) including positive temperature coefficient (PTC) resistors, working as resetable fuses, in series with thick film resistors.

Note that it is important to always use PTC's in series with resistors not sensitive to temperature, as the PTC will act as a capacitance for fast transients and therefore the ability to protect the SLIC will be reduced.

If there is a risk overvoltages on the $\rm V_{\scriptscriptstyle Bat}$ terminal on the SLIC, then this terminal should also be protected.

Over-Temperature Protection

A ring lead to ground short circuit fault condition, as well as other improper operating modes, may cause excessive SLIC power dissipation. If junction temperature increases beyond 140°C, the temperature guard will trigger, causing the SLIC to be set to a high impedance state. In this high impedance state power dissipation is reduced and the junction temperature will return to a safe value. Once below 130 °C junction temperature the SLIC is returned back to its normal operating mode and will remain in that state assuming the fault condition has been removed.

Power-Up Sequence

The voltage at pin VBAT sets the substrate voltage V_{QBat} (supplied internally from V_{Bat} through a resistor), which must at all times be kept more negative than the voltage at any other terminal. This is to maintain correct junction isolation between devices on the chip. To prevent possible latch-up, the optimal power-up sequence is to connect ground and V_{Bat} then other supply voltages and signal leads. Should the $\mathrm{V}_{_{\mathrm{Bat}}}$ supply voltage be absent or if VEE or VCC must for other reasons be connected before VBAT, a diode with low forward voltage drop (Schottky diode or a diode with a 1 A current rating) connected with its cathode to VEE and anode to VQBAT, ensures the presence of the most negative supply voltage at the VQBAT pin.

The V_{Bat} voltage should not be applied at a faster rate than $dV_{Bat}/dt = 4 V/\mu sec$, e.g. a time constant formed by a 5.1 Ω resistor in series with the VBAT pin and a 0.47 microfarad capacitor from the VBAT pin to ground. One resistor may be shared by several SLICs.

Printed Circuit Board Layout

Care in PCB layout is essential for proper function. The components connecting to the RSN input should be placed in close proximity to that pin, such that no interference is injected into the RSN terminal. A ground plane surrounding the RSN pin is advisable. The C_{HP} capacitor should be placed close to terminals HPT and HPR to avoid unwanted disturbances.

The switch mode regulator components must be located near the pins to which they connect. It is particularly important that the catch diode and the inductor are connected via shortest possible trace lengths.

Ground terminals GND1 and GND2 should be connected via a direct PCB trace at the device location.

Ordering Information

Package Part No.	Temp. Range	
Plastic DIP	0 to 70°C	PBL 3798N
PLCC 44 pin	0 to 70°C	PBL 3798QN
PLCC 32 pin	0 to 70°C	PBL 3798RN
PLCC 44 pin	0 to 70°C	PBL 3798/2QN
PLCC 32 pin	0 to 70°C	PBL 3798/2RN

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